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Jameco Part Number 818937

## CMOS 8-Stage Shift-and-Store Bus Register

High-Voltage Types (20-Volt Rating)

■ CD4094B is an 8-stage serial shift register having a storage latch associated with each stage for strobing data from the serial input to parallel buffered 3-state outputs. The parallel outputs may be connected directly to common bus lines. Data is shifted on positive clock transitions. The data in each shift register stage is transferred to the storage register when the STROBE input is high. Data in the storage register appears at the outputs whenever the OUTPUT-ENABLE signal is high.

Two serial outputs are available for cascading a number of CD4094B devices. Data is available at the Q<sub>S</sub> serial output terminal on positive clock edges to allow for high-speed operation in cascaded systems in which the clock rise time is fast. The same serial information, available at the Q<sub>S</sub> terminal on the next negative clock edge, provides a means for cascading CD4094B devices when the clock rise time is slow.

The CD4094B types are supplied in 16-lead hermetic dual-in-line ceramic packages (F3A suffix), 16-lead dual-in-line plastic packages (E suffix), 16-lead small-outline packages (NSR suffix), and 16-lead thin shrink small-outline packages (PW and PWR suffixes).

### Features:

- 3-state parallel outputs for connection to common bus
- Separate serial outputs synchronous to both positive and negative clock edges for cascading
- Medium speed operation – 5 MHz at 10 V (typ.)
- Standardized, symmetrical output characteristics
- 100% tested for quiescent current at 20 V
- Maximum input current of 1  $\mu$ A at 18 V over full package-temperature range; 100 nA at 18 V and 25°C
- Noise margin (full package temperature range):  
1 V at V<sub>DD</sub> = 5 V      2 V at V<sub>DD</sub> = 10 V  
2.5 V at V<sub>DD</sub> = 15 V
- 5-V, 10-V, and 15-V parametric ratings
- Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"

### Applications:

- Serial-to-parallel data conversion
- Remote control holding register
- Dual-rank shift, hold, and bus applications

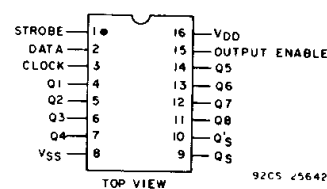
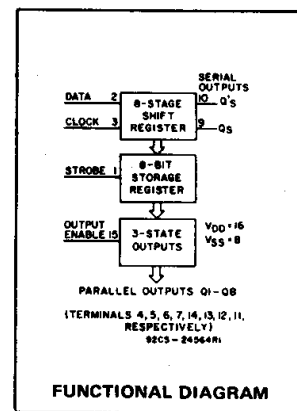


Fig. 1 – Terminal assignment.

### MAXIMUM RATINGS, Absolute-Maximum Values:

DC SUPPLY-VOLTAGE RANGE, (V<sub>DD</sub>)

Voltages referenced to V<sub>SS</sub> Terminal) ..... -0.5V to +20V

INPUT VOLTAGE RANGE, ALL INPUTS ..... -0.5V to V<sub>DD</sub> +0.5V

DC INPUT CURRENT, ANY ONE INPUT .....  $\pm$ 10mA

POWER DISSIPATION PER PACKAGE (P<sub>D</sub>):

For T<sub>A</sub> = -55°C to +100°C ..... 500mW

For T<sub>A</sub> = +100°C to +125°C ..... Derate Linearly at 12mW/°C to 200mW

DEVICE DISSIPATION PER OUTPUT TRANSISTOR

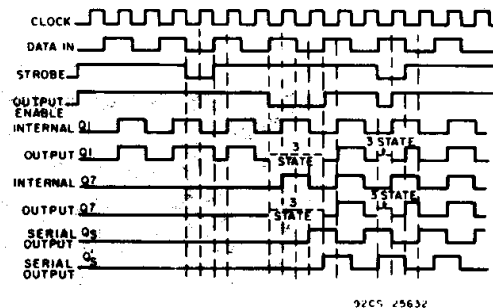
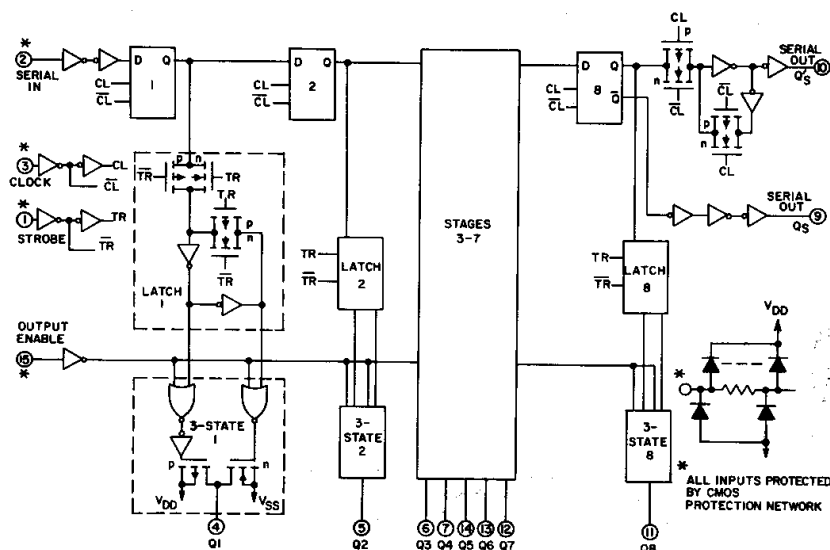
FOR T<sub>A</sub> = FULL PACKAGE-TEMPERATURE RANGE (All Package Types) ..... 100mW

OPERATING-TEMPERATURE RANGE (T<sub>A</sub>) ..... -55°C to +125°C

STORAGE TEMPERATURE RANGE (T<sub>stg</sub>) ..... -65°C to +150°C

LEAD TEMPERATURE (DURING SOLDERING):

At distance 1/16  $\pm$  1/32 inch (1.59  $\pm$  0.79mm) from case for 10s max ..... +265°C



# CD4094B Types

**RECOMMENDED OPERATING CONDITIONS** at  $T_A = 25^\circ\text{C}$ , Except as Noted.  
For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

| CHARACTERISTIC                                                   | VDD<br>(V)    | LIMITS           |                  | UNITS         |
|------------------------------------------------------------------|---------------|------------------|------------------|---------------|
|                                                                  |               | MIN.             | MAX.             |               |
| Supply-Voltage Range (For $T_A$ =Full Package-Temperature Range) |               | 3                | 18               | V             |
| Data Setup Time, $t_S$                                           | 5<br>10<br>15 | 125<br>55<br>35  | —<br>—<br>—      | ns            |
| Clock Pulse Width, $t_W$                                         | 5<br>10<br>15 | 200<br>100<br>83 | —<br>—<br>—      | ns            |
| Clock Input Frequency, $f_{CL}$                                  | 5<br>10<br>15 | dc               | 1.25<br>2.5<br>3 | MHz           |
| Clock Input Rise or Fall time,<br>$t_{rCL}$ , $t_{fCL}$ *        | 5<br>10<br>15 | —                | 15<br>5<br>5     | $\mu\text{s}$ |
| Strobe Pulse Width, $t_W$                                        | 5<br>10<br>15 | 200<br>80<br>70  | —<br>—<br>—      | ns            |

\*If more than one unit is cascaded  $t_{rCL}$  (for  $Q_S$  only) should be made less than or equal to the sum of the fixed propagation delay at 50 pF and the transition time of the output driving stage for the estimated capacitive load.

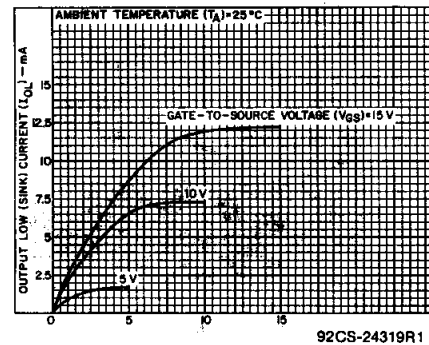


Fig. 5 - Minimum output low (sink) current characteristics.

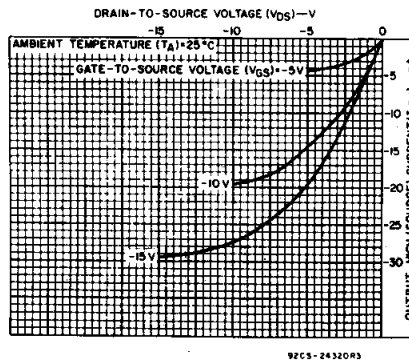


Fig. 6 - Typical output high (source) current characteristics.

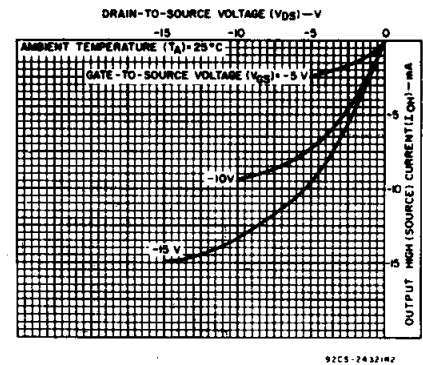


Fig. 7 - Minimum output high (source) current characteristics.

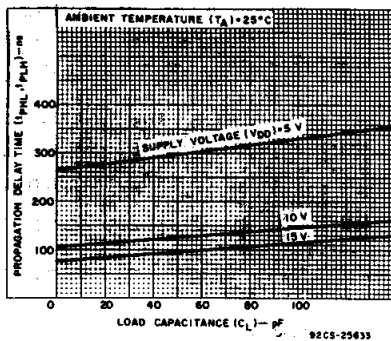


Fig. 8 - Clock-to-serial output  $Q_S$  propagation delay vs  $C_L$ .

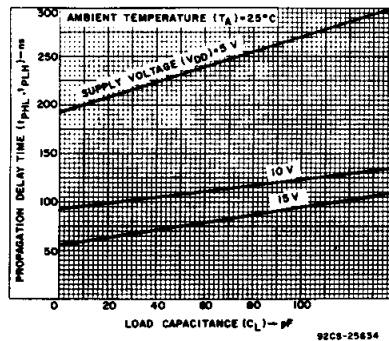


Fig. 9 - Clock-to-serial output  $Q'_S$  propagation delay vs  $C_L$ .

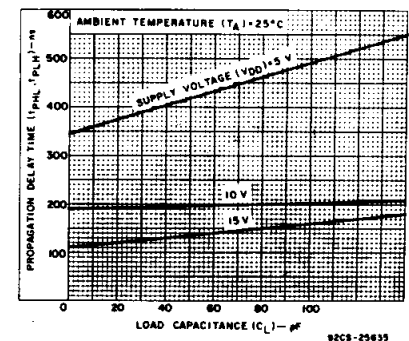


Fig. 10 - Clock-to-parallel output propagation delay vs  $C_L$ .

TRUTH TABLE

| CL <sup>Δ</sup> | Output Enable | Strobe | Data | Parallel Outputs |                   | Serial Outputs   |                 |
|-----------------|---------------|--------|------|------------------|-------------------|------------------|-----------------|
|                 |               |        |      | Q1               | Q <sub>N</sub>    | Q <sub>S</sub> * | Q' <sub>S</sub> |
| 0               | 0             | X      | X    | OC               | OC                | Q7               | NC              |
| 0               | 0             | X      | X    | OC               | OC                | NC               | Q7              |
| 1               | 0             | 0      | X    | NC               | NC                | Q7               | NC              |
| 1               | 1             | 1      | 0    | 0                | Q <sub>N</sub> -1 | Q7               | NC              |
| 1               | 1             | 1      | 1    | 1                | Q <sub>N</sub> -1 | Q7               | NC              |
| 1               | 1             | 1      | 1    | NC               | NC                | NC               | Q7              |

<sup>Δ</sup> = Level Change

X = Don't Care

NC = No Change

OC = Open Circuit

Logic 1  $\equiv$  High

Logic 0  $\equiv$  Low

\* At the positive clock edge information in the 7th shift register stage is transferred to the 8th register stage and the  $Q_S$  output.

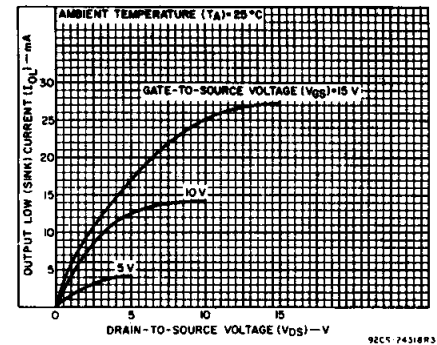


Fig. 4 - Typical output low (sink) current characteristics.

# CD4094B Types

## STATIC ELECTRICAL CHARACTERISTICS

| CHARACTER-<br>ISTIC                                         | CONDITIONS            |                        |                        | LIMITS AT INDICATED TEMPERATURES (°C) |       |       |       |       |                   |      | UNITS |
|-------------------------------------------------------------|-----------------------|------------------------|------------------------|---------------------------------------|-------|-------|-------|-------|-------------------|------|-------|
|                                                             | V <sub>O</sub><br>(V) | V <sub>IN</sub><br>(V) | V <sub>DD</sub><br>(V) |                                       |       |       |       | +25   |                   |      |       |
|                                                             |                       |                        |                        | -55                                   | -40   | +85   | +125  | Min.  | Typ.              | Max. |       |
| Quiescent Device<br>Current,<br>I <sub>DD</sub> Max.        | —                     | 0,5                    | 5                      | 5                                     | 5     | 150   | 150   | —     | 0.04              | 5    | μA    |
|                                                             | —                     | 0,10                   | 10                     | 10                                    | 10    | 300   | 300   | —     | 0.04              | 10   |       |
|                                                             | —                     | 0,15                   | 15                     | 20                                    | 20    | 600   | 600   | —     | 0.04              | 20   |       |
|                                                             | —                     | 0,20                   | 20                     | 100                                   | 100   | 3000  | 3000  | —     | 0.08              | 100  |       |
| Output Low<br>(Sink) Current<br>I <sub>OL</sub> Min.        | 0.4                   | 0,5                    | 5                      | 0.64                                  | 0.61  | 0.42  | 0.36  | 0.51  | 1                 | —    | mA    |
|                                                             | 0.5                   | 0,10                   | 10                     | 1.6                                   | 1.5   | 1.1   | 0.9   | 1.3   | 2.6               | —    |       |
|                                                             | 1.5                   | 0,15                   | 15                     | 4.2                                   | 4     | 2.8   | 2.4   | 3.4   | 6.8               | —    |       |
| Output High<br>(Source)<br>Current,<br>I <sub>OH</sub> Min. | 4.6                   | 0,5                    | 5                      | -0.64                                 | -0.61 | -0.42 | -0.36 | -0.51 | -1                | —    | mA    |
|                                                             | 2.5                   | 0,5                    | 5                      | -2                                    | -1.8  | -1.3  | -1.15 | -1.6  | -3.2              | —    |       |
|                                                             | 9.5                   | 0,10                   | 10                     | -1.6                                  | -1.5  | -1.1  | -0.9  | -1.3  | -2.6              | —    |       |
|                                                             | 13.5                  | 0,15                   | 15                     | -4.2                                  | -4    | -2.8  | -2.4  | -3.4  | -6.8              | —    |       |
| Output Voltage:<br>Low-Level,<br>V <sub>OL</sub> Max.       | —                     | 0,5                    | 5                      | 0.05                                  |       |       |       | —     | 0                 | 0.05 | V     |
|                                                             | —                     | 0,10                   | 10                     | 0.05                                  |       |       |       | —     | 0                 | 0.05 |       |
|                                                             | —                     | 0,15                   | 15                     | 0.05                                  |       |       |       | —     | 0                 | 0.05 |       |
| Output Voltage:<br>High-Level,<br>V <sub>OH</sub> Min.      | —                     | 0,5                    | 5                      | 4.95                                  |       |       |       | 4.95  | 5                 | —    | V     |
|                                                             | —                     | 0,10                   | 10                     | 9.95                                  |       |       |       | 9.95  | 10                | —    |       |
|                                                             | —                     | 0,15                   | 15                     | 14.95                                 |       |       |       | 14.95 | 15                | —    |       |
| Input Low<br>Voltage,<br>V <sub>IL</sub> Max.               | 0.5, 4.5              | —                      | 5                      | 1.5                                   |       |       |       | —     | —                 | 1.5  | V     |
|                                                             | 1, 9                  | —                      | 10                     | 3                                     |       |       |       | —     | —                 | 3    |       |
|                                                             | 1.5, 13.5             | —                      | 15                     | 4                                     |       |       |       | —     | —                 | 4    |       |
| Input High<br>Voltage,<br>V <sub>IH</sub> Min.              | 0.5, 4.5              | —                      | 5                      | 3.5                                   |       |       |       | 3.5   | —                 | —    | V     |
|                                                             | 1, 9                  | —                      | 10                     | 7                                     |       |       |       | 7     | —                 | —    |       |
|                                                             | 1.5, 13.5             | —                      | 15                     | 11                                    |       |       |       | 11    | —                 | —    |       |
| Input Current<br>I <sub>IN</sub> Max.                       | —                     | 0,18                   | 18                     | ±0.1                                  | ±0.1  | ±1    | ±1    | —     | ±10 <sup>-5</sup> | ±0.1 | μA    |
| 3-State Output<br>Leakage Current<br>I <sub>OUT</sub> Max.  | 0,18                  | 0,18                   | 18                     | ±0.4                                  | ±0.4  | ±12   | ±12   | —     | ±10 <sup>-4</sup> | ±0.4 | μA    |

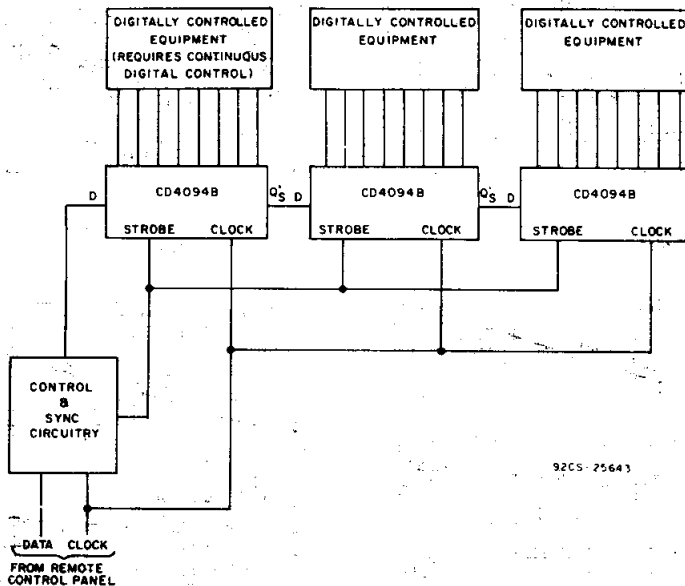


Fig. 14 — Remote control holding register.

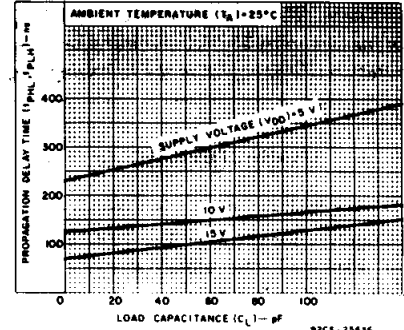


Fig. 11 — Strobe-to-parallel output propagation delay vs.  $C_L$ .

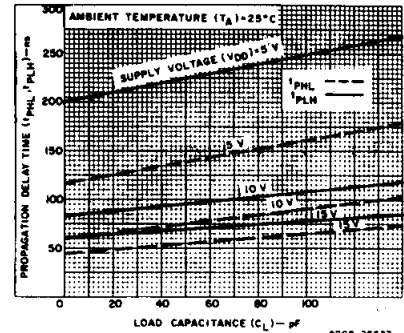


Fig. 12 — Output enable-to-parallel output propagation delay vs.  $C_L$ .

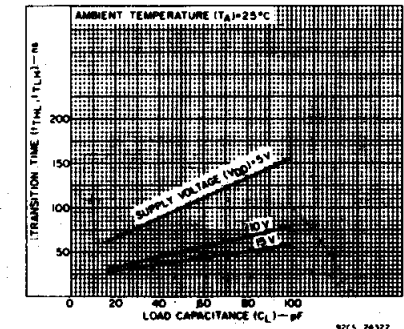


Fig. 13 — Typical transition time vs. load capacitance.

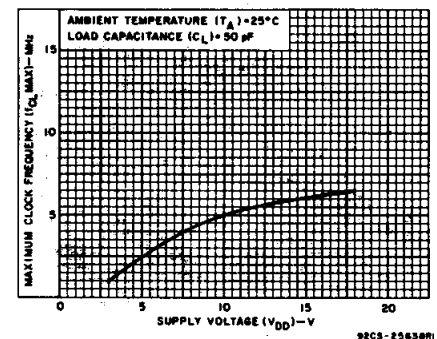


Fig. 15 — Typical maximum-clock-frequency vs. supply voltage.

# CD4094B Types

## DYNAMIC ELECTRICAL CHARACTERISTICS

At  $T_A = 25^\circ\text{C}$ ; Input  $t_r, t_f = 20\text{ ns}$ ,  $C_L = 50\text{ pF}$ ,  $R_L = 200\text{ k}\Omega$

| CHARACTERISTIC                                               | VDD<br>(V) | LIMITS |      |      | UNITS         |
|--------------------------------------------------------------|------------|--------|------|------|---------------|
|                                                              |            | MIN.   | TYP. | MAX. |               |
| Propagation Delay Time,<br>$t_{PHL}, t_{PLH}$                | 5          | —      | 300  | 600  | ns            |
| Clock to Serial Output $Q_S$                                 | 10         | —      | 125  | 250  |               |
|                                                              | 15         | —      | 95   | 190  |               |
| Clock to Serial Output $Q_S'$                                | 5          | —      | 230  | 460  | ns            |
|                                                              | 10         | —      | 110  | 220  |               |
|                                                              | 15         | —      | 75   | 150  |               |
| Clock to Parallel Output                                     | 5          | —      | 420  | 840  | ns            |
|                                                              | 10         | —      | 195  | 390  |               |
|                                                              | 15         | —      | 135  | 270  |               |
| Strobe to Parallel Output                                    | 5          | —      | 290  | 580  | ns            |
|                                                              | 10         | —      | 145  | 290  |               |
|                                                              | 15         | —      | 100  | 200  |               |
| Output Enable to Parallel<br>Output:<br>$t_{PHZ}, t_{PZH}$   | 5          | —      | 140  | 280  | ns            |
|                                                              | 10         | —      | 60   | 120  |               |
|                                                              | 15         | —      | 45   | 90   |               |
| $t_{PLZ}, t_{PZL}$                                           | 5          | —      | 100  | 200  | ns            |
|                                                              | 10         | —      | 50   | 100  |               |
|                                                              | 15         | —      | 40   | 80   |               |
| Minimum Strobe Pulse<br>Width, $t_W$                         | 5          | —      | 100  | 200  | ns            |
|                                                              | 10         | —      | 40   | 80   |               |
|                                                              | 15         | —      | 35   | 70   |               |
| Minimum Clock Pulse<br>Width, $t_W$                          | 5          | —      | 100  | 200  | ns            |
|                                                              | 10         | —      | 50   | 100  |               |
|                                                              | 15         | —      | 40   | 83   |               |
| Minimum Data Setup<br>Time, $t_S$                            | 5          | —      | 60   | 125  | ns            |
|                                                              | 10         | —      | 30   | 55   |               |
|                                                              | 15         | —      | 20   | 35   |               |
| Transition Time;<br>$t_{THL}, t_{TLH}$                       | 5          | —      | 100  | 200  | ns            |
|                                                              | 10         | —      | 50   | 100  |               |
|                                                              | 15         | —      | 40   | 80   |               |
| Maximum Clock Input Rise<br>or Fall Time, $t_{rCL}, t_{fCL}$ | 5          | 15     | —    | —    | $\mu\text{s}$ |
|                                                              | 10         | 5      | —    | —    |               |
|                                                              | 15         | 5      | —    | —    |               |
| Maximum Clock Input<br>Frequency, $f_{CL}$                   | 5          | 1.25   | 2.5  | —    | MHz           |
|                                                              | 10         | 2.5    | 5    | —    |               |
|                                                              | 15         | 3      | 6    | —    |               |
| Input Capacitance $C_{IN}$<br>(Any Input)                    | —          | —      | 5    | 7.5  | pF            |

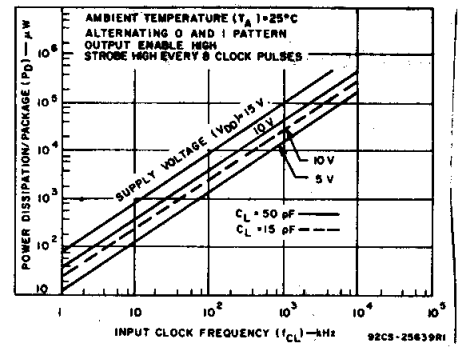


Fig. 16 - Dynamic power dissipation vs input clock frequency.

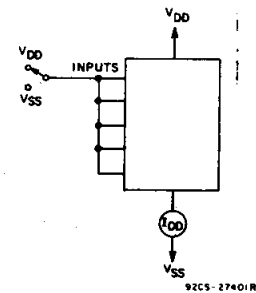


Fig. 17 - Quiescent device current test circuit.

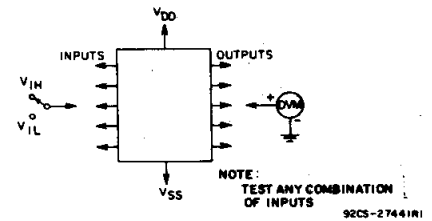


Fig. 18 - Input voltage test circuit.

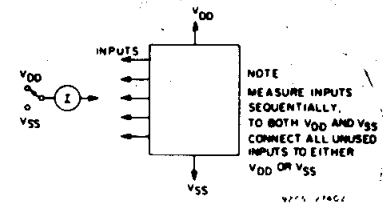
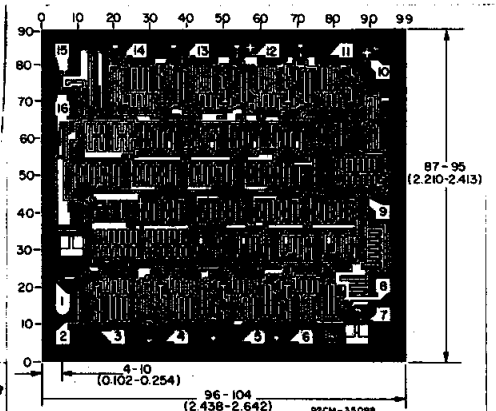


Fig. 19 - Input current test circuit.



Dimensions and Pad Layout for CD4094B Chip.

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils ( $10^{-3}$  inch).

**PACKAGING INFORMATION**

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| 7702501EA        | ACTIVE                | CDIP         | J               | 16   | 1           | TBD                     | A42 SNPB         | N / A for Pkg Type           |
| CD4094BE         | ACTIVE                | PDIP         | N               | 16   | 25          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| CD4094BEE4       | ACTIVE                | PDIP         | N               | 16   | 25          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| CD4094BF         | ACTIVE                | CDIP         | J               | 16   | 1           | TBD                     | A42 SNPB         | N / A for Pkg Type           |
| CD4094BF3A       | ACTIVE                | CDIP         | J               | 16   | 1           | TBD                     | A42 SNPB         | N / A for Pkg Type           |
| CD4094BNSR       | ACTIVE                | SO           | NS              | 16   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4094BNSRE4     | ACTIVE                | SO           | NS              | 16   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4094BPW        | ACTIVE                | TSSOP        | PW              | 16   | 90          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4094BPWE4      | ACTIVE                | TSSOP        | PW              | 16   | 90          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4094BPWR       | ACTIVE                | TSSOP        | PW              | 16   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4094BPWRE4     | ACTIVE                | TSSOP        | PW              | 16   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBsolete:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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J (R-GDIP-T\*\*)

14 LEADS SHOWN

# CERAMIC DUAL IN-LINE PACKAGE



| PINS **<br>DIM | 14                     | 16                     | 18                     | 20                     |
|----------------|------------------------|------------------------|------------------------|------------------------|
| A              | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC |
| B MAX          | 0.785<br>(19,94)       | .840<br>(21,34)        | 0.960<br>(24,38)       | 1.060<br>(26,92)       |
| B MIN          | —                      | —                      | —                      | —                      |
| C MAX          | 0.300<br>(7,62)        | 0.300<br>(7,62)        | 0.310<br>(7,87)        | 0.300<br>(7,62)        |
| C MIN          | 0.245<br>(6,22)        | 0.245<br>(6,22)        | 0.220<br>(5,59)        | 0.245<br>(6,22)        |



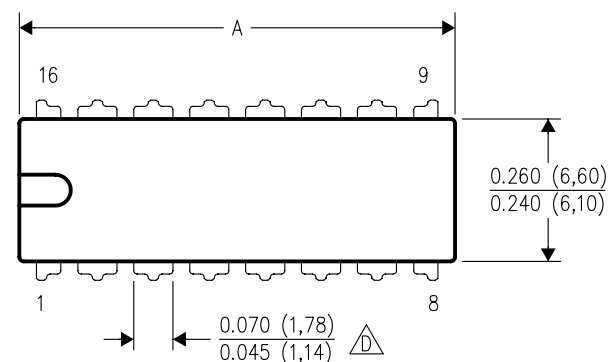
4040083/F 03/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package is hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
  - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

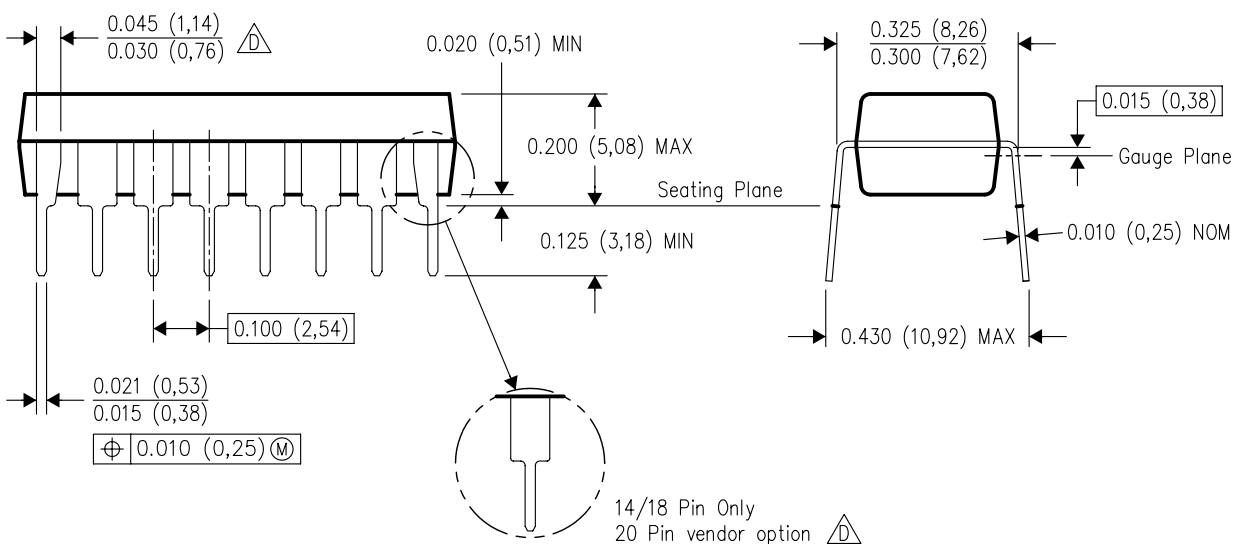
N (R-PDIP-T\*\*)

16 PINS SHOWN

## PLASTIC DUAL-IN-LINE PACKAGE



| PINS **<br>DIM      | 14               | 16               | 18               | 20               |
|---------------------|------------------|------------------|------------------|------------------|
| A MAX               | 0.775<br>(19,69) | 0.775<br>(19,69) | 0.920<br>(23,37) | 1.060<br>(26,92) |
| A MIN               | 0.745<br>(18,92) | 0.745<br>(18,92) | 0.850<br>(21,59) | 0.940<br>(23,88) |
| MS-001<br>VARIATION | AA               | BB               | AC               | AD               |



4040049/E 12/2002

NOTES:

- A. All linear dimensions are in inches (millimeters).  
B. This drawing is subject to change without notice.
-  Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).  
 The 20 pin end lead shoulder width is a vendor option, either half or full width.

# MECHANICAL DATA

NS (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

## PW (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153

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Mailing Address: Texas Instruments  
Post Office Box 655303 Dallas, Texas 75265

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